

2SB0930 (2SB930), 2SB0930A (2SB930A)

Silicon PNP epitaxial planar type

For power amplification

Complementary to 2SD1253, 2SD1253A

■ Features

- High forward current transfer ratio h_{FE} which has satisfactory linearity
- Low collector-emitter saturation voltage $V_{CE(sat)}$
- N type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment.

■ Absolute Maximum Ratings $T_C = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	2SB0930	V_{CBO}	-60	V
	2SB0930A		-80	
Collector-emitter voltage (Base open)	2SB0930	V_{CEO}	-60	V
	2SB0930A		-80	
Emitter-base voltage (Collector open)	V_{EBO}	-5	V	
Collector current	I_C	-4	A	
Peak collector current	I_{CP}	-8	A	
Collector power dissipation	P_C		40	W
		$T_a = 25^\circ\text{C}$	1.3	
Junction temperature	T_j	150	$^\circ\text{C}$	
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$	

■ Electrical Characteristics $T_C = 25^\circ\text{C} \pm 3^\circ\text{C}$

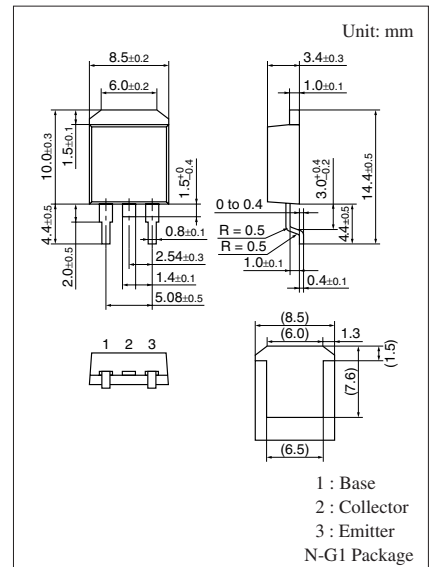
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-emitter voltage (Base open)	2SB0930	$I_C = -30 \text{ mA}, I_B = 0$	-60			V
	2SB0930A		-80			
Collector-emitter cutoff current (E-B short)	2SB0930	$V_{CE} = -60 \text{ V}, V_{BE} = 0$			-400	μA
	2SB0930A				-400	
Collector-emitter cutoff current (Base open)	2SB0930	$V_{CE} = -30 \text{ V}, I_B = 0$			-700	μA
	2SB0930A				-700	
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = -5 \text{ V}, I_C = 0$			-1	mA
Forward current transfer ratio	h_{FE1}^*	$V_{CE} = -4 \text{ V}, I_C = -1 \text{ A}$	70		250	—
	h_{FE2}	$V_{CE} = -4 \text{ V}, I_C = -3 \text{ A}$	15			
Base-emitter voltage	V_{BE}	$V_{CE} = -4 \text{ V}, I_C = -3 \text{ A}$			-2.0	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = -4 \text{ A}, I_B = -0.4 \text{ A}$			-1.5	V
Transition frequency	f_T	$V_{CE} = -10 \text{ V}, I_C = -0.5 \text{ A}, f = 10 \text{ MHz}$		20		MHz
Turn-on time	t_{on}	$I_{B1} = -0.4 \text{ A}, I_{B2} = 0.4 \text{ A}$		0.2		μs
Storage time	t_{stg}				0.5	μs
Fall time	t_f		$V_{CC} = -50 \text{ V}$		0.2	μs

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

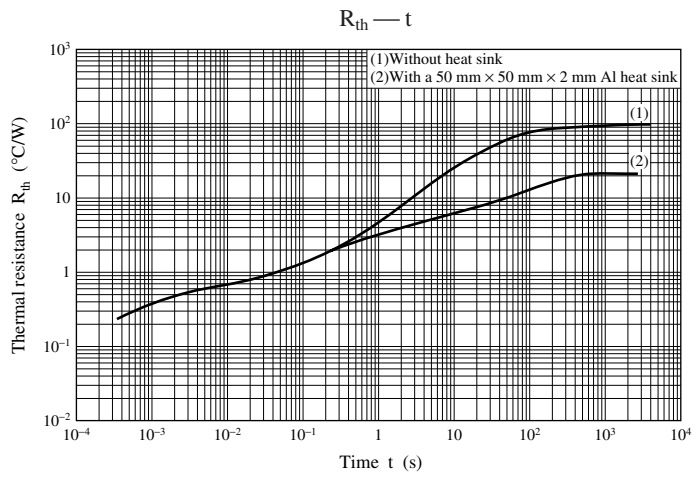
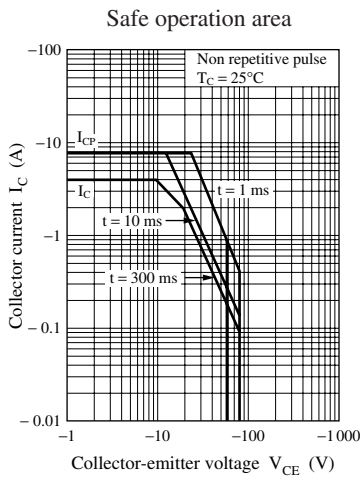
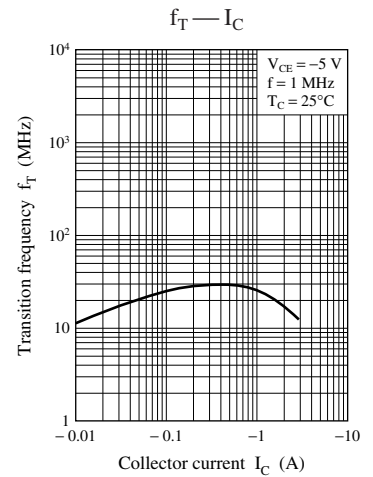
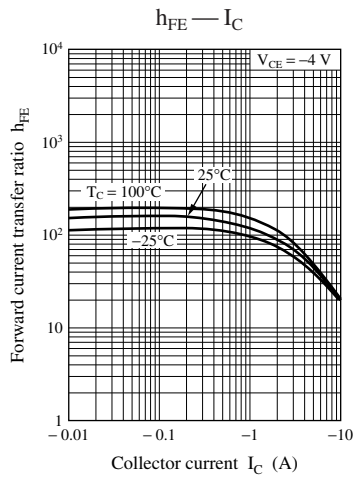
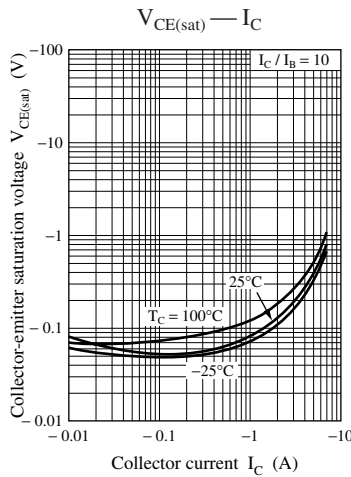
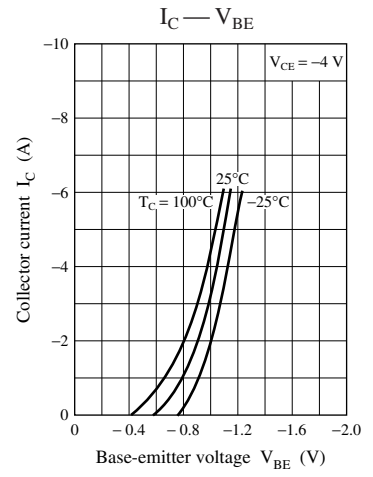
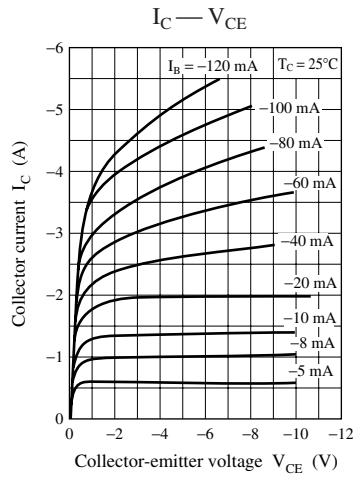
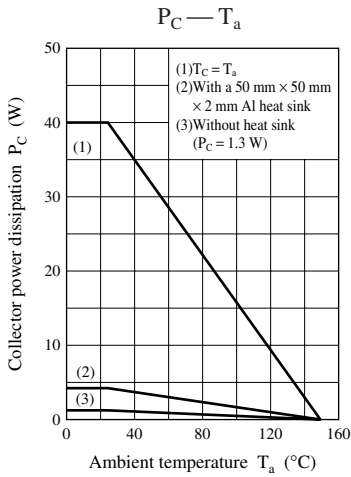
2. *: Rank classification

Rank	Q	P
h_{FE1}	70 to 150	120 to 250

Note) The part number in the parenthesis shows conventional part number.



Note) Self-supported type package is also prepared.



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